

Component Metallizations

PC10904HV

Silver Conductor

Description:

PC10904HV is a high performance silver conductor designed for metallizing ceramic component devices. The rheology of PC10904HV is optimized for dipping and spraying methods of application.

● **Key Benefits:**

- Excellent conductivity
- High adhesion to various oxide substrates
- Optimized for dipping and spraying applications

● **Typical Properties:**

Resistivity:

< 1.5 milliohms per square
at 25 microns fired film thickness.

Viscosity

8.5 – 9.5 Kcps Brookfield RVT
Spindle #5 @ 20 rpm, 25°C

Solderability:

3 seconds dip
Sn62/Pb36/Ag2, 200°C

Excellent

Solder Leaching:

Sn62/Pb36/Ag2, 230°C
50% loss of 10mil wide conductor trace

5 x 5 second dips

Adhesion:

62Sn/36Pb/2Ag, 230°C
80 mil x 80 mil pad

Initial: > 6 lbs

● **Recommended Processing Guidelines:**

Application:

The material should be thoroughly shaken before use.
Apply the material by dipping or spraying.

Drying:

Dry at 125-150°C for 5-10 minutes.

Firing:

850°C - 925°C peak temperature
Dwell time of 5-10minutes dwell time.

Thinner:

RV-404 (Butyl Acetate)

Warranty:

Material guaranteed to meet specifications
for 6 months from date of shipment.

Storage:

Store in a dry location at 5°C-25°C.

DO NOT REFRIGERATE.

Allow paste to come to room temperature
prior to opening.
Spatulate well before using.

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The descriptions and engineering data shown here have been compiled by Heraeus using commonly-accepted procedures, in conjunction with modern testing equipment, and have been compiled as according to the latest factual knowledge in our possession. The information was up-to date on the date this document was printed (latest versions can always be supplied upon request). Although the data is considered accurate, we cannot guarantee accuracy, the results obtained from its use, or any patent infringement resulting from its use (unless this is contractually and explicitly agreed in writing, in advance). The data is supplied on the condition that the user shall conduct tests to determine materials suitability for a particular application.

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